Old Company Name in Catalogs and Other Documents

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April 1st, 2010 Renesas Electronics Corporation

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DATA SHEET



MOS FIELD EFFECT TRANSISTOR NP80N06MLG, NP80N06NLG, NP80N06PLG

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The NP80N06MLG, NP80N06NLG, and NP80N06PLG are N-channel MOS Field Effect Transistors designed for high current switching applications.

ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
NP80N06MLG-S18-AY Note		Tube	TO-220 (MP-25K) typ. 1.9 g
NP80N06NLG-S18-AY Note		50 p/tube	TO-262 (MP-25SK) typ. 1.8 g
NP80N06PLG-E1B-AY Note	Pure Sn (Tin)	Tape	
NP80N06PLG-E2B-AY Note		1000 p/reel	TO-263 (MP-25ZP) typ. 1.5 g

Note Pb-free (This product does not contain Pb in the external electrode.)

FEATURES (TO-220)

- Logic level
- Built-in gate protection diode
- Super low on-state resistance
 - NP80N06MLG, NP80N06NLG

 $R_{DS(on)1} = 8.6 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = 10 \text{ V, I}_D = 40 \text{ A)}$

 $R_{DS(on)2} = 13.3 \text{ m}\Omega \text{ MAX}. \text{ (Vgs = 4.5 V, ID = 35 A)}$

- NP80N06PLG

 $R_{DS(on)1}$ = 8.3 m Ω MAX. (Vgs = 10 V, Ip = 40 A)

 $R_{DS(on)2} = 13 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.5 \text{ V}, I_D = 35 \text{ A})$

• High current rating

 $I_{D(DC)} = \pm 80 A$

• Low input capacitance

Ciss = 4600 pF TYP.

• Designed for automotive application and AEC-Q101 qualified



(TO-262)



(TO-263)



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ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Drain to Source Voltage (VGS = 0 V)	VDSS	60	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	I _{D(DC)}	±80	Α
Drain Current (pulse) Note1	D(pulse)	±180	Α
Total Power Dissipation (Tc = 25°C)	P _{T1}	115	W
Total Power Dissipation (T _A = 25°C)	P _{T2}	1.8	W
Channel Temperature	Tch	175	°C
Storage Temperature	T _{stg}	-55 to +175	°C
Repetitive Avalanche Current Note2	lar	32	Α
Repetitive Avalanche Energy Note2	Ear	102	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Tch \leq 150°C, Rg = 25 Ω

THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	1.30	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W

ELECTRICAL CHARACTERISTICS (TA = 25°C)

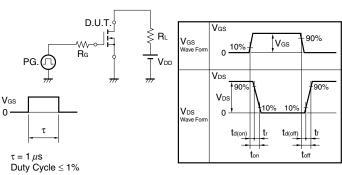
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
Gate Leakage Current	Igss	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μΑ
Gate to Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1.4		2.5	V
Forward Transfer Admittance Note	y fs	V _{DS} = 5 V, I _D = 35 A	25	59		S
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = 10 V, ID = 40 A NP80N06MLG, NP80N06NLG		6.7	8.6	mΩ
		V _{GS} = 10 V, I _D = 40 A NP80N06PLG		6.2	8.3	mΩ
	RDS(on)2	V _{GS} = 4.5 V, I _D = 35 A NP80N06MLG, NP80N06NLG		8.4	13.3	mΩ
		V _{GS} = 4.5 V, I _D = 35 A NP80N06PLG		7.6	13	mΩ
Input Capacitance	Ciss	V _{DS} = 25 V,		4600	6900	pF
Output Capacitance	Coss	V _{GS} = 0 V,		370	560	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		220	400	pF
Turn-on Delay Time	td(on)	V _{DD} = 30 V, I _D = 40 A,		17	37	ns
Rise Time	tr	V _{GS} = 10 V,		13	33	ns
Turn-off Delay Time	td(off)	$R_G = 0 \Omega$		70	140	ns
Fall Time	tf			7	18	ns
Total Gate Charge	QG	V _{DD} = 48 V,		85	128	nC
Gate to Source Charge	QGS	V _{GS} = 10 V,		14		nC
Gate to Drain Charge	Q _{GD}	I _D = 80 A		25		nC
Body Diode Forward Voltage Note	V _{F(S-D)}	I _F = 80 A, V _{GS} = 0 V		0.96	1.5	V
Reverse Recovery Time	trr	I _F = 80 A, V _{GS} = 0 V,		41		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		56		nC

Note Pulsed test

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = 20 \rightarrow 0 \text{ V}$ $R_{G} = 25 \Omega$ $S_{D} = 20 \rightarrow 0 \text{ V}$ $R_{G} = 25 \Omega$ $S_{D} = 20 \rightarrow 0 \text{ V}$ $R_{G} = 25 \Omega$ $S_{D} = 20 \rightarrow 0 \text{ V}$ $R_{G} = 25 \Omega$ $S_{D} = 20 \rightarrow 0 \text{ V}$ $R_{G} = 25 \Omega$ $R_{G} = 25 \Omega$

TEST CIRCUIT 2 SWITCHING TIME



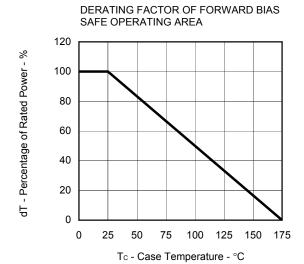
TEST CIRCUIT 3 GATE CHARGE

$$\begin{array}{c|c}
D.U.T. \\
IG = 2 \text{ mA} \\
\hline
VOD
\end{array}$$

$$\begin{array}{c|c}
PG. & \downarrow \\
\hline
VOD
\end{array}$$

Starting Tch

TYPICAL CHARACTERISTICS (TA = 25°C)



CASE TEMPERATURE 125 P_T - Total Power Dissipation - W 100 75

50

25

0

0

25

50

TOTAL POWER DISSIPATION vs.

Tc - Case Temperature - °C

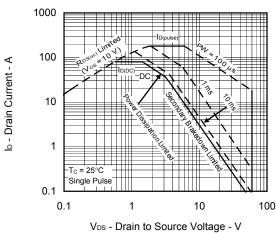
100 125

150

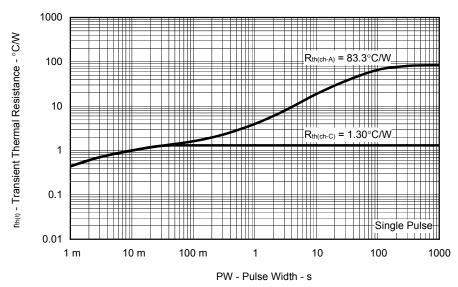
175

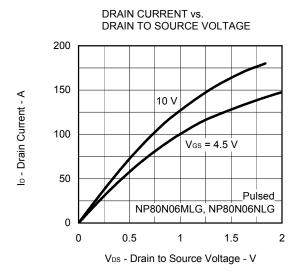
75

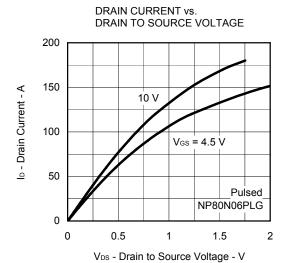
FORWARD BIAS SAFE OPERATING AREA



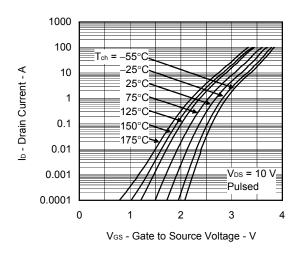
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



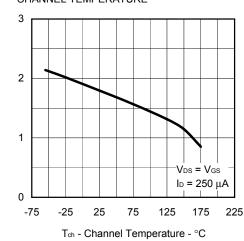




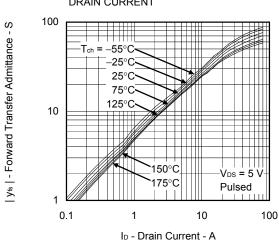
FORWARD TRANSFER CHARACTERISTICS



GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

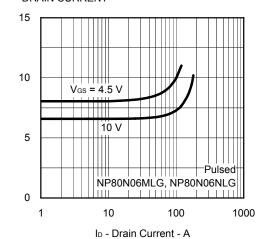


Vos(th) - Gate to Source Threshold Voltage - V

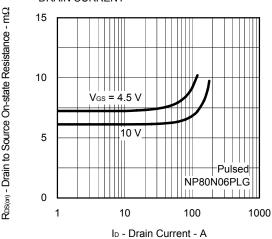
R_{DS(m)} - Drain to Source On-state Resistance - mΩ

R_{DS(m)} - Drain to Source On-state Resistance - mΩ

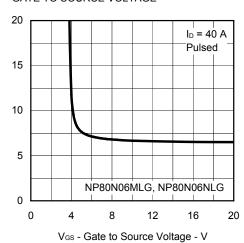
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



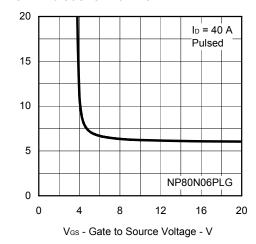
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



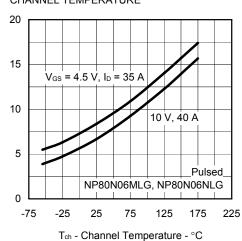
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



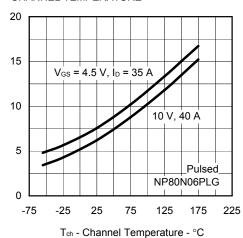
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE

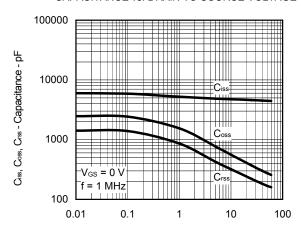


 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - Drain to Source On-state Resistance - $\mathsf{m}\Omega$

R_{DS(m)} - Drain to Source On-state Resistance - mΩ

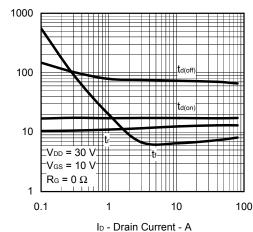
R_{DS(m)} - Drain to Source On-state Resistance - mΩ

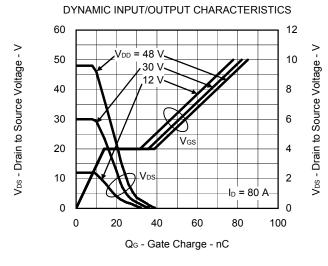
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



 $V_{\text{\scriptsize DS}}$ - Drain to Source Voltage - V

SWITCHING CHARACTERISTICS

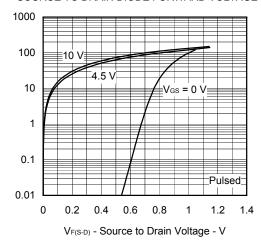




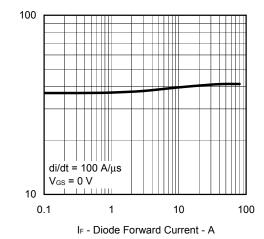
I - Diode Forward Current - A

ta(on), tr, ta(om, tr - Switching Time - ns

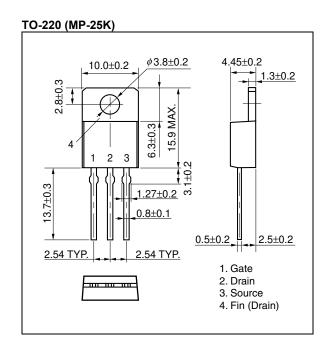
SOURCE TO DRAIN DIODE FORWARD VOLTAGE

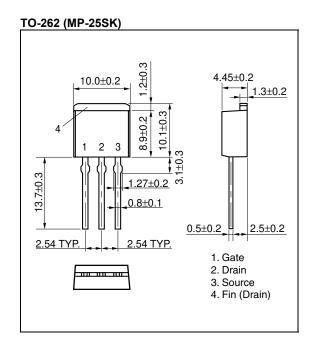


REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

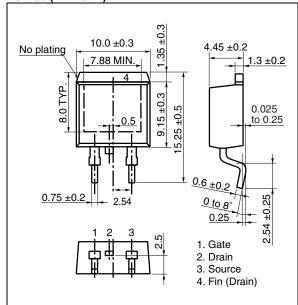


PACKAGE DRAWINGS (Unit: mm)

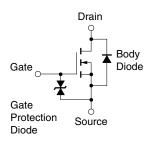




TO-263 (MP-25ZP)



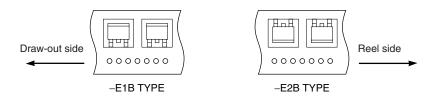
EQUIVALENT CIRCUIT



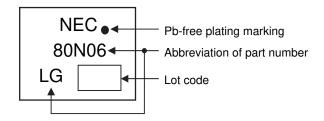
Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

TAPE INFORMATION (NP80N06PLG)

There are two types (-E1B, -E2B) of taping depending on the direction of the device.



MARKING INFORMATION



RECOMMENDED SOLDERING CONDITIONS

These products should be soldered and mounted under the following recommended conditions.

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For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow NP80N06PLG	Maximum temperature (Package's surface temperature): 260°C or below Time at maximum temperature: 10 seconds or less Time of temperature higher than 220°C: 60 seconds or less Preheating time at 160 to 180°C: 60 to 120 seconds Maximum number of reflow processes: 3 times Maximum chlorine content of rosin flux (percentage mass): 0.2% or less	IR60-00-3
Wave soldering NP80N06MLG, NP80N06NLG	Maximum temperature (Solder temperature): 260°C or below Time: 10 seconds or less Maximum chlorine content of rosin flux: 0.2% (wt.) or less	THDWS
Partial heating NP80N06MLG, NP80N06NLG, NP80N06PLG	Maximum temperature (Pin temperature): 350°C or below Time (per side of the device): 3 seconds or less Maximum chlorine content of rosin flux: 0.2% (wt.) or less	P350

Caution Do not use different soldering methods together (except for partial heating).

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